



T768

3U Active Air Cooler

PRODUCT SPECIFICATIONS

T768 | Socket LGA 115X/1200

Model Number: T768

- Recommended for Intel® Processors As Following
 - Intel® Xeon® Processor E3 v4 Family, Socket FCLGA 1150
 - Intel® Xeon® E Processor/Intel Core™ i7 Processor, Socket FCLGA 1151;
 - Intel® Xeon® Processor E3 Family/Intel Core™ i5 Processor, Socket LGA 1155;
 - Intel® Xeon® processor X3400, Socket LGA 1156;
 - Intel® Core™ i9 Processor, Socket FCLGA 1200;
- Active Cooler for Workstation, 3U Server & Up

Overall Specification

Dimension	98.0 x 98.0 x 110.0 mm (L x W x H)
Weight	530 ± 5 g
Material	Aluminum Fin + (4x) Heat Pipes with HCC enhancement
Heat Pipes	Smart Heat Pipes Orientation where Against Gravity
Fan	92 CM Plastic Quiet Fan with 4-Pin PWM Connector
Fan Mounting	Pre-installed solid PC Frame Clip for Cooling Fan mounting
Mounting Method	Easy Cooler Installation with Captive Mounting Screws
Backing Plate	Included
Thermal Grease	Shin-Etsu 7762 or Equivalent Thermal Compound Pre-Printed
TDP	Up to 125 Watts CPU Power Heat Dissipation

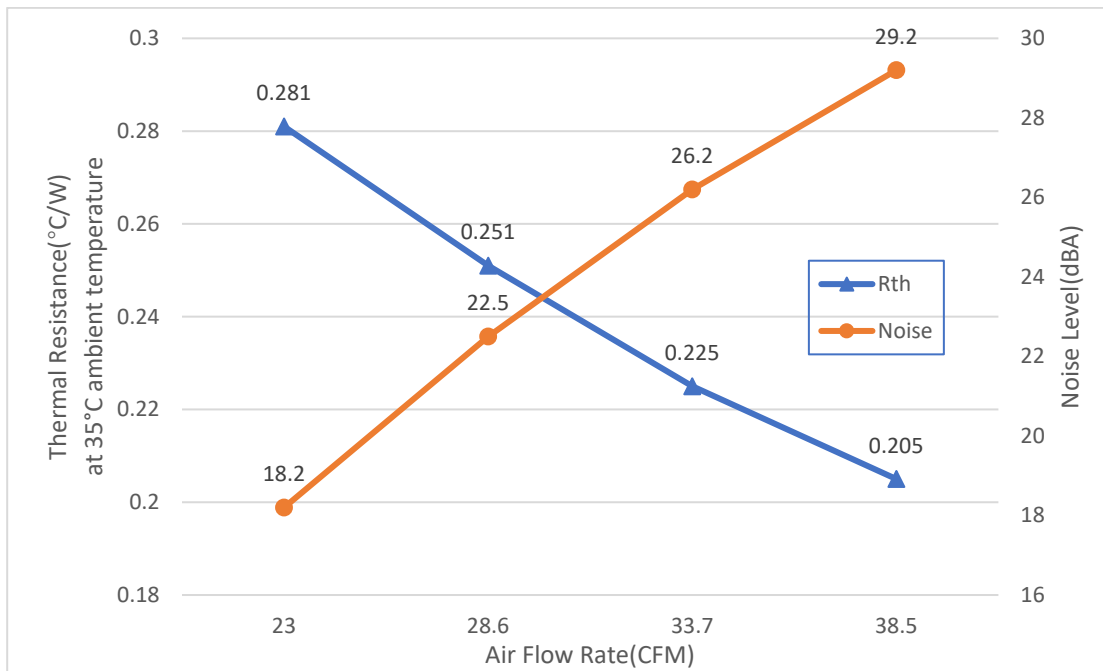
Cooling Fan Specification

Model Number	DF129225BM-PWMG
Dimension	Ø92 x 25 mm
Bearing	Double Ball
Rated Voltage	12V
Rated Speed	At Duty Cycle 0~20%: 1000 ± 200 RPM At Duty Cycle 50%: 1800 ±10% RPM At Duty Cycle 100%: 2500 ±10% RPM
Input Power	At Duty Cycle 0~20%: 0.96 W At Duty Cycle 50%: 1.44 W At Duty Cycle 100%: 3.0 W
Maximum Airflow	At Duty Cycle 0~20%: 17.34 CFM At Duty Cycle 50%: 31.21 CFM At Duty Cycle 100%: 43.36 CFM
Rated Static Pressure	At Duty Cycle 0~20%: 0.48 mm-H2O At Duty Cycle 50%: 1.155 mm-H2O At Duty Cycle 100%: 3.0 mm-H2O

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Acoustical Noise	At Duty Cycle 0~20%: 17.0 dBA At Duty Cycle 50%: 24.78 dBA At Duty Cycle 100%: 31.92 dBA
Lead Wire Pin Out	Pin#1- Black(-) Pin#2- Yellow(+) Pin#3- Green(Tachometer/ Signal Output) Pin#4- Blue (PWM)

Performance Chart: Active Cooler T768 Thermal Resistance Cooling Performance vs. Airflow



Cooling Performance vs. Fan Speed

